

FDPF17N60NT N-Channel UniFETTM II MOSFET 600 V, 17 A, 340 mΩ

Features

- + $R_{DS(on)}$ = 290 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 8.5 A
- Low Gate Charge (Typ. 48 nC)
- Low C_{rss} (Typ. 23 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- RoHS Compliant

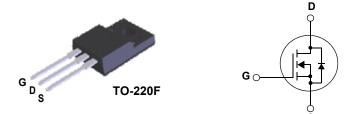
Applications

- LCD/LED/PDP TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply



Description

UniFETTM II MOSFET is Fairchild Semiconductor[®]'s high voltage MOSFET family based on advanced planar stripe and DMOS technology. This advanced MOSFET family has the smallest on-state resistance among the planar MOSFET, and also provides superior switching performance and higher avalanche energy strength. In addition, internal gate-source ESD diode allows UniFET II MOSFET to withstand over 2kV HBM surge stress. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Thermal Resistance, Junction to Ambient, Max.

Symbol	Parameter			FDPF17N60NT	Unit
V _{DSS}	Drain to Source Voltage			600	V
V _{GSS}	Gate to Source Voltage			±30	V
I _D	Drain Current	- Continuous (T _C = 25 ^o C)		17*	A
		- Continuous (T _C = 100 ^o C)		10.2*	- A
I _{DM}	Drain Current	- Pulsed	(Note 1)	68*	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		(Note 2)	838	mJ
I _{AR}	Avalanche Current (Note 1)		(Note 1)	17	А
E _{AR}	Repetitive Avalanche Energy (Note 1)		(Note 1)	24.5	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		(Note 3)	10	V/ns
P _D	Power Dissipation	$(T_{\rm C} = 25^{\rm o}{\rm C})$		62.5	W
		- Derate above 25°C		0.5	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C
	imited by maximum junction temperat Characteristics	ure	·		
Symbol	Parameter			FDPF17N60NT	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.		2.0	0000	
D	Thermal Decistence, Junction to Ambient May			60 F	°C/W

 $R_{\theta JA}$

62.5

Device Marking Device		Packag	ckage Reel Size Tape		e Width		Quantity			
<u> </u>		TO-220	F			50				
Electrica	l Char	racteristics ⊤ _c =	25°C unless of	otherwise	e noted			I		
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristic							iyp.	mux.	Unit
BV _{DSS}		ain to Source Breakdown Voltage		I _D = 250μA, V _{GS} = 0V, T _C = 25 ^o C		600		_	V	
ΔBV_{DSS} ΔT_J	Breakd	Breakdown Voltage Temperature		$I_D = 250 \mu$ A, Referenced to 25° C			-	0.8	-	V/°C
	7 0			V _{DS} = 600V, V _{GS} = 0V		-	-	1		
DSS	Zero Gate Voltage Drain Current		ent	$V_{DS} = 480V, V_{GS} = 0V, T_{C} = 150^{\circ}C$			-	-	10	μA
I _{GSS}	Gate to	Gate to Body Leakage Current		$V_{GS} = \pm 30V, V_{DS} = 0V$		-	-	±100	nA	
On Charac	teristic	S								
V _{GS(th)}		hreshold Voltage		$V_{CS} = V$	/ _{DS} , I _D = 250μA		3.0	-	5.0	V
R _{DS(on)}		Drain to Source On Resistance		$V_{GS} = 10V, I_D = 8.5A$			-	0.29	0.34	Ω
9 _{FS}	Forwar	ard Transconductance		$V_{DS} = 20V, I_D = 8.5A$			-	21	-	S
C _{iss} C _{oss}	Output	apacitance Capacitance		$V_{DS} = 25V, V_{GS} = 0V$ f = 1MHz $V_{DS} = 480V I_D = 17A$ $V_{GS} = 10V$ (Note 4)		-	2285 310	3040 410	pF pF	
C _{rss}		e Transfer Capacitance	9			-	23	35	pF	
Q _{g(tot)}		ate Charge at 10V				-	48	65	nC	
Q _{gs}		Source Gate Charge					-	13	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge				-	20	-	nC	
Switching	Charac	teristics								
t _{d(on)}	Turn-O	n Delay Time		$V_{DD} = 300V, I_D = 17A$ $V_{GS} = 10V, R_{GEN} = 25\Omega$ (Note 4)			-	48	106	ns
t _r	Turn-O	n Rise Time				-	79	168	ns	
t _{d(off)}	Turn-O	ff Delay Time				-	128	266	ns	
t _f	Turn-O	ff Fall Time				-	62	134	ns	
Drain-Sou	rce Dio	de Characteristic	s							
I _S	Maximum Continuous Drain to Source Diode Forward Current			-	-	74	Α			
I _{SM}	Maximum Pulsed Drain to Source Diode Fo		rce Diode For	orward Current		-	-	68	Α	
V _{SD}	Drain to	Source Diode Forward	d Voltage	$V_{GS} = 0$	V, I _{SD} = 17A		-	-	1.4	V
t _{rr}	Reverse	e Recovery Time		$V_{GS} = 0V, I_{SD} = 17A$ $dI_F/dt = 100A/\mu s$			-	575	-	ns
Q _{rr}	-	e Recovery Charge					7.2		μC	

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. L = 5.8mH, I_{AS} = 17A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

3. $I_{SD} \leq$ 17A, di/dt \leq 200A/µs, $V_{DD} \leq BV_{DSS},$ Starting T_J = 25°C

4. Essentially Independent of Operating Temperature Typical Characteristics

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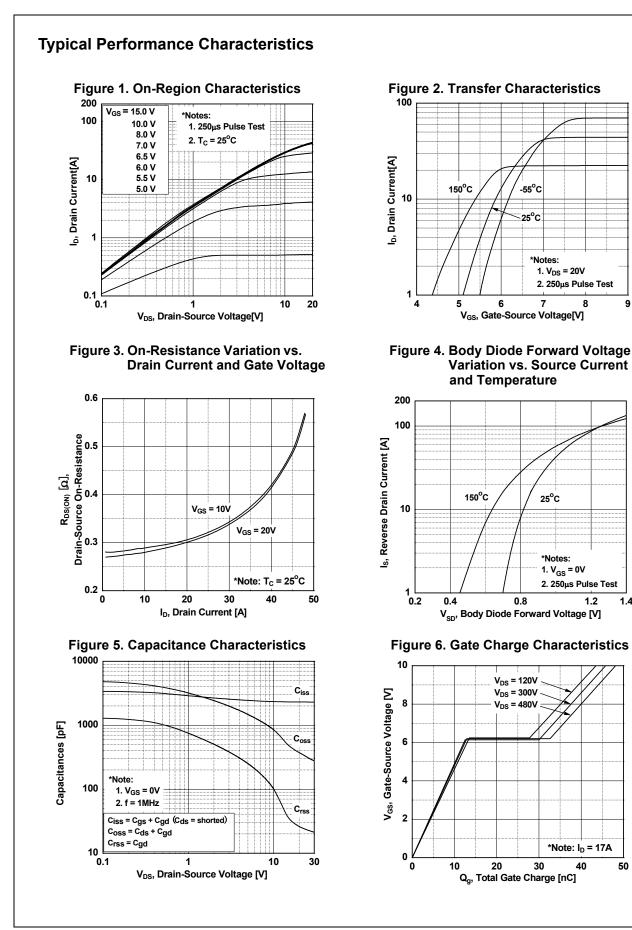


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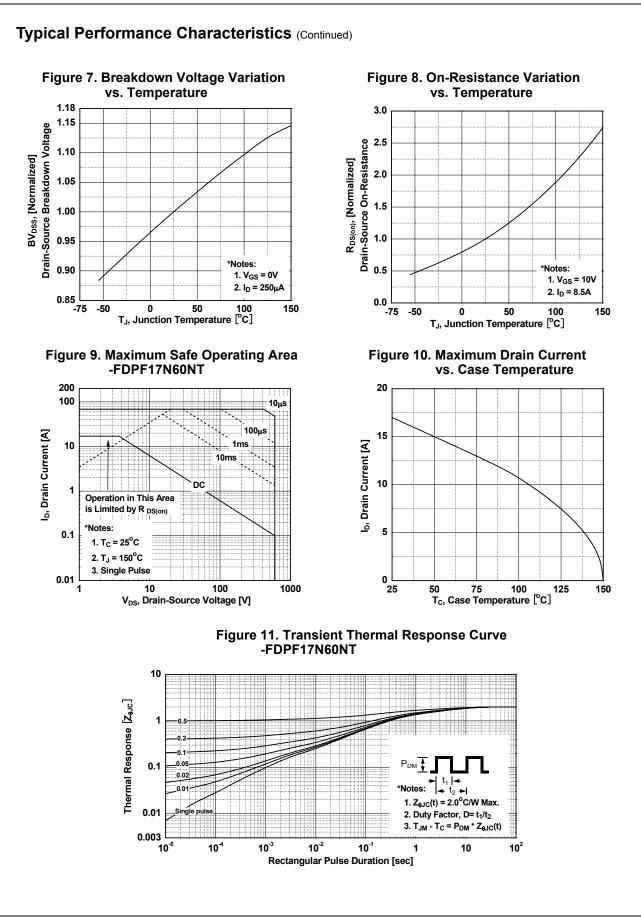
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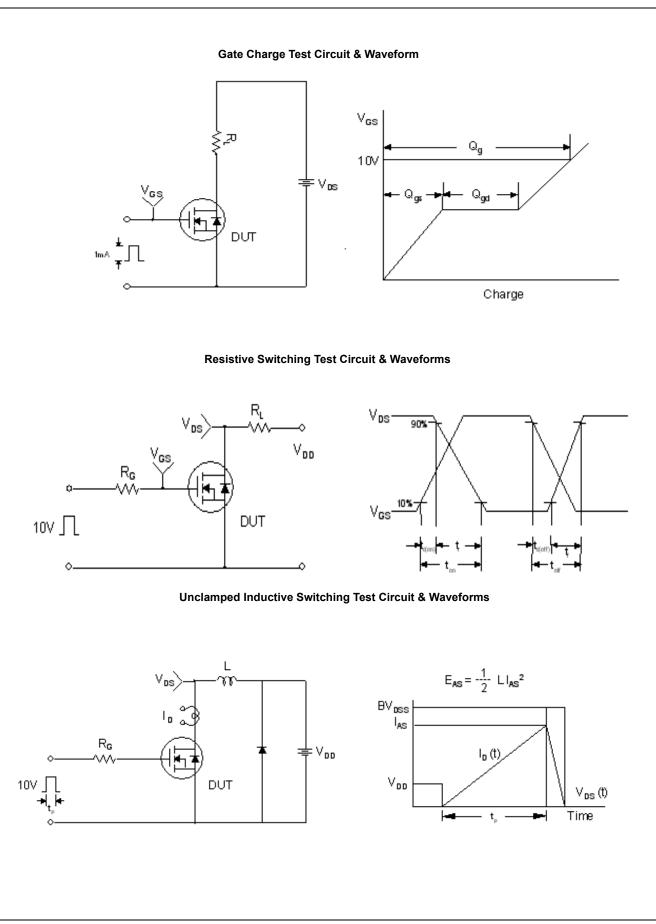
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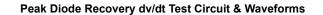
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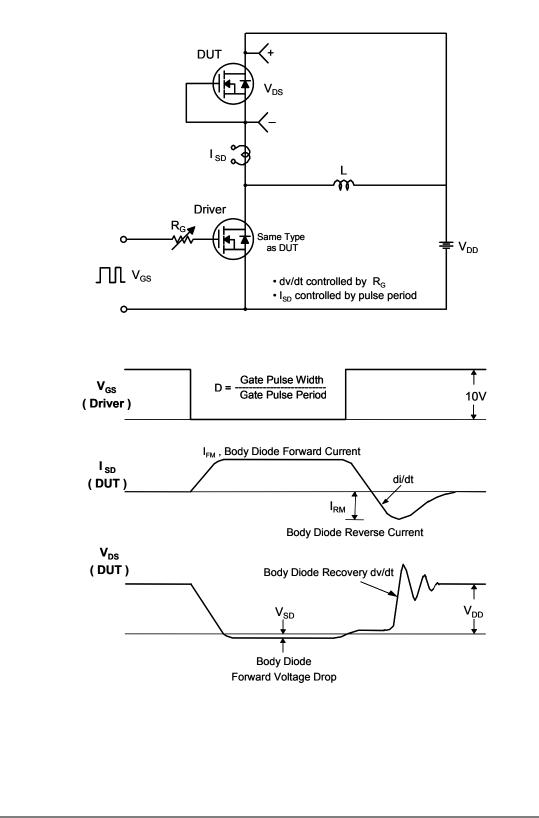
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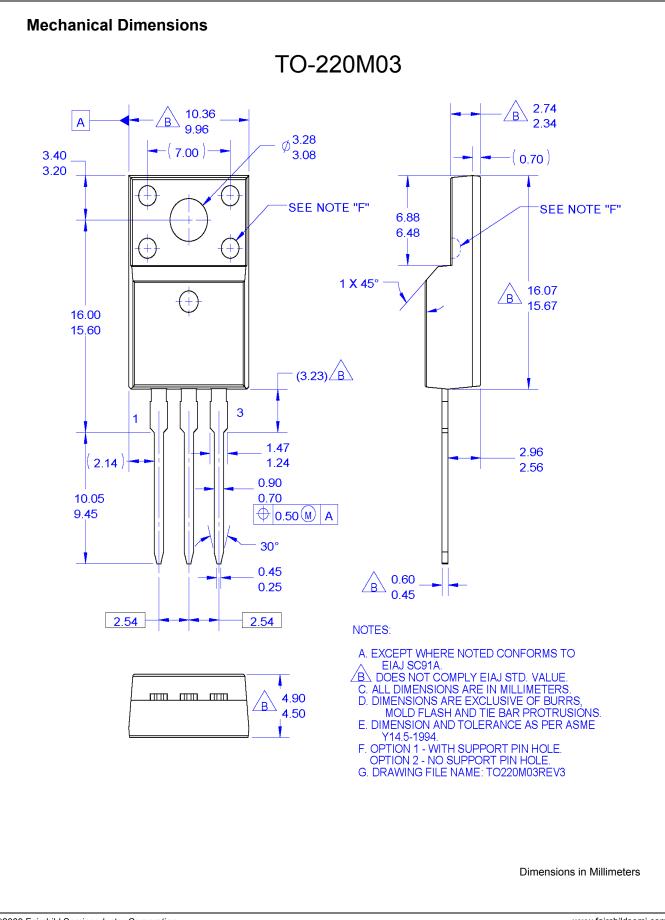




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